## <u>Government launches enhanced</u> <u>Technology Talent Admission Scheme</u>

â€<The Innovation and Technology Commission today (January 30) launched the enhancement measures of the Technology Talent Admission Scheme (TechTAS) as announced in the Chief Executive's 2019 Policy Address. Eligible companies are welcome to apply for the enhanced scheme.

When it was launched, TechTAS covered tenants and incubatees of the Hong Kong Science and Technology Parks Corporation and Hong Kong Cyberport Management Company Limited which conducted research and development (R&D) activities in seven technology areas, i.e. artificial intelligence, biotechnology, cybersecurity, data analytics, financial technologies, material science and robotics. With the enhancements, TechTAS now covers six new technology areas, namely 5G communications, digital entertainment, green technology, integrated circuit design, the Internet of Things and microelectronics, and its coverage is extended to all companies conducting R&D activities in the aforementioned 13 technology areas in Hong Kong.

The enhancements of TechTAS will allow more companies to benefit from the certainty and streamlined procedures offered by the scheme, thus expediting the admission of technology talent from different parts of the world to undertake R&D work in Hong Kong, encouraging cross-fertilisation of local and non-local talent and contributing to Hong Kong's innovation and technology development.

Launched in June 2018, TechTAS provides a fast-track arrangement for admitting overseas and Mainland technology talent. Successful companies will be given quotas for bringing in such people for undertaking R&D work. More information is available on the TechTAS website (techtas.itc.gov.hk). For enquiries, please contact the Innovation and Technology Commission (Email: techtas@itc.gov.hk).